

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Shani Keysar	10/10/2011
Reuven Holzer	10/11/2011
Ofer Navon	10/11/2011
Rami Friedlander	10/11/2011
RECEIVING PARTY DATA	
Name:	Sol Chip Ltd.
Street Address:	59 Albert Schweitzer
City:	Haifa
State/Country:	ISRAEL
Postal Code:	34995
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13270869
CORRESPONDENCE DATA	
Fax Number:	(866)864-3947
Phone:	973-401-7157
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>	
Correspondent Name:	MYERS WOLIN, LLC
Address Line 1:	100 HEADQUARTERS PLAZA
Address Line 2:	North Tower, 6th Floor
Address Line 4:	MORRISTOWN, NEW JERSEY 07960-6834
ATTORNEY DOCKET NUMBER:	SLCP 2327
NAME OF SUBMITTER:	Brian S. Myers
Total Attachments: 2 source=slcp_2327_20111011_asgn#page1.tif source=slcp_2327_20111011_asgn#page2.tif	

OP \$40.00 13270869

ASSIGNMENT

WHEREAS, the below named inventor(s), ASSIGNOR, has made a certain new and useful invention in **AN INTEGRATED CIRCUIT COMBINATION OF A TARGET INTEGRATED CIRCUIT AND A PLURALITY OF CELLS CONNECTED THERETO USING THE TOP CONDUCTIVE LAYER**, for which an application:

- is being filed concurrently herewith, or
- was filed on _____, as U.S. or PCT Application

WHEREAS, **Sol Chip Ltd.**, having an address at **59 Albert Schweitzer, Haifa, Israel 34995**, ASSIGNEE, is desirous of obtaining the entire right, title and interest in, to and under the said invention and the said application.

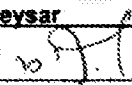
NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to me in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, the said ASSIGNOR has sold, assigned, transferred and set over, and by these presents does hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof, and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventor's certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

ASSIGNOR authorizes and requests the Commissioner of Patents and Trademarks of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument; and

ASSIGNOR covenants and agrees that he has full right to convey the entire interest herein assigned, and has not executed, and will not execute, any agreement in conflict herewith; and

ASSIGNOR further covenants and agrees that he will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.


Full name of first inventor: Shani Keysar

Inventor's Signature:  Date: 10 Oct 2011

Residence: Haifa, IL Citizenship: IL

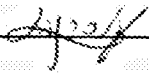
Post Office Address: c/o Sol Chip Ltd., 59 Albert Schweitzer, Haifa, Israel 34995

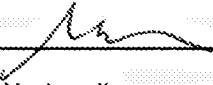
2. Full name of joint inventor: Reuven Holzer

Inventor's Signature:  Date: 11 Oct 2011

Residence: Herzlia, IL Citizenship: IL

Post Office Address: c/o Sol Chip Ltd., 59 Albert Schweitzer, Haifa, Israel 34995

3. Full name of joint inventor: Ofer Navon
Inventor's Signature:  Date: 11 Oct 2011
Residence: Pardes Hanna, IL Citizenship: IL
Post Office Address: c/o Sol Chip Ltd., 59 Albert Schweitzer, Haifa, Israel 34995

4. Full name of joint inventor: Ram Friedlander
Inventor's Signature:  Date: 11 Oct 2011
Residence: Zichron Yaakov, IL Citizenship: IL
Post Office Address: c/o Sol Chip Ltd., 59 Albert Schweitzer, Haifa, Israel 34995